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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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MBRS3100T3G, NRVBS3100T3G

Surface Mount Schottky Power Rectifier

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard-Ring for Stress Protection
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable*
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant
- Mechanical Characteristics
- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings:
 - ♦ Machine Model = C
 - Human Body Model = 3B



ON Semiconductor®

www.onsemi.com

SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES, 100 VOLTS



SMC 2-LEAD CASE 403AC

MARKING DIAGRAM



B310	= Specific Device Code
А	= Assembly Location**
Y	= Year
WW	= Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

** The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRS3100T3G	SMC 2–Lead (Pb–Free)	2,500 / Tape & Reel
NRVBS3100T3G*	SMC 2–Lead (Pb–Free)	2,500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MBRS3100T3G, NRVBS3100T3G

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
Average Rectified Forward Current (At Rated V_R , $T_L = 100^{\circ}C$)	I _{F(AV)}	3.0	A
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	130	A
Operating Junction Temperature Range (Note 1)	TJ	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead		11	°C/W

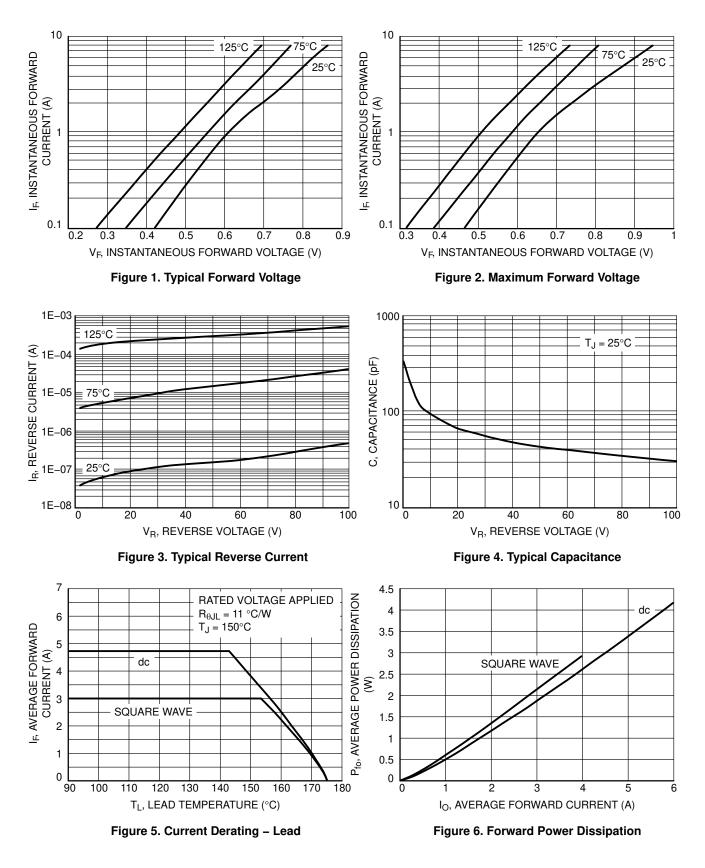
ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
	VF	0.79 0.90 0.62 0.70	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 125^{\circ}C$)	İR	0.05 5.0	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.

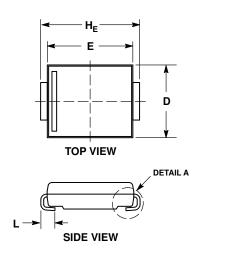
MBRS3100T3G, NRVBS3100T3G

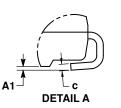
TYPICAL CHARACTERISTICS

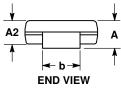


PACKAGE DIMENSIONS

SMC 2-LEAD CASE 403AC ISSUE A







NOTES:

3.

1. DIMENSIONING AND TOLERANCING PER ANME Y14.5M, 1994.

CONTROLLING DIMENSION: INCHES. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD

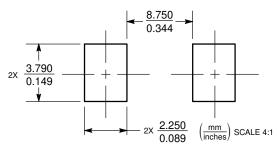
Solution of the second se

DETERMINED BY DIMENSION L.

MILLIMETERS INCHES
DIM MIN MAX MIN MAX

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.95	2.61	0.077	0.103
A1	0.05	0.20	0.002	0.008
A2	1.90	2.41	0.075	0.095
b	2.90	3.20	0.114	0.126
c	0.15	0.41	0.060	0.016
D	5.55	6.25	0.219	0.246
E	6.60	7.15	0.260	0.281
HE	7.75	8.15	0.305	0.321
L	0.75	1.60	0.030	0.063
	A A1 A2 b c D E	DIM MIN A 1.95 A1 0.05 A2 1.90 b 2.90 c 0.15 D 5.55 E 6.60 HE 7.75	DIM MIN MAX A 1.95 2.61 A1 0.05 0.20 A2 1.90 2.41 b 2.90 3.20 c 0.15 0.41 D 5.55 6.25 E 6.60 7.15 HE 7.75 8.15	DIM MIN MAX MIN A 1.95 2.61 0.077 A1 0.05 0.20 0.002 A2 1.90 2.41 0.075 b 2.90 3.20 0.114 c 0.155 0.41 0.060 D 5.55 6.25 0.219 E 6.60 7.15 0.2600 H _E 7.75 8.15 0.305

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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